



BOARD CHARACTERISTICS

Copper Layer Count:	6	Board Thickness:	62.99 mils
Board overall dimensions:	3550.00 mils x 3982.07 mils		
Min track/spacing:	6.00 mils / 5.00 mils	Min hole diameter:	10.00 mils
Copper Finish:	ENIG	Impedance Control:	No
Castellated pads:	No	Plated Board Edge:	No
Edge card connectors:	Yes, Bevelled		

NOTES:

Assemble with leaded solder.
Green soldermask, White silkscreen.
Fabricate on Isola FR408HR.
1oz outer, 1oz inner copper.

Sheet:			
File: mainboard.kicad_pcb			
Title:			
Size: A4	Date:		Rev:
KiCad E.D.A.	KiCad (6.0.5)		Id: 1/1